JJMICROELECTRONICS

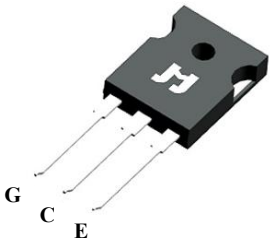
1200V 15A Trench and Field Stop IGBT

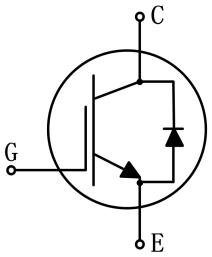
JJT15N120SE

Key performance:

- V_{CE}=1200V
- I_C=15A@T_C=100℃
- $V_{CE(sat)}$=1.7V

TO-247





Features:

- Trench and field-stop technology
- Low collector to emitter saturation voltage
- Easy parallel switching capability
- Short circuit withstands time 10μs
- High ruggedness performance
- RoHS compliant

Applications:

- Inverter
- Motor driver

Package parameters

Type	Marking	Package	Packaging Method
JJT15N120SE	T15120SE	TO-247	Tube

Maximum ratings

Symbol	Parameter	Values	Unit
V_{CES}	Collector-emitter voltage	1200	V
V_{GES}	Gate-emitter voltage	±20	V
I_C	Continuous collector current (T_C=25℃)	30	A
	Continuous collector current (T_C=100℃)	15	A
I_{CM}	Pulsed collector current, t_p limited by T_{vjmax}	60	A
I_F	Diode continuous forward current (T_C=100℃)	15	A
I_{FM}	Diode maximum current, t_p limited by T_{vjmax}	60	A
t_{sc}	Short circuit withstand time	10	μs
P_{tot}	Power dissipation (T_C=25℃)	375	W
	Power dissipation (T_C=100℃)	187	W
T_{vj}	Operating junction temperature range	-40 to +175	℃
T_{stg}	Storage temperature range	-55 to +150	℃

Thermal characteristics

Symbol	Parameter	Values		Unit
		Typ.	Max.	
$R_{th(j-c)}$	Thermal resistance, junction to case for IGBT	-	0.4	K/ W
$R_{th(j-c)}$	Thermal resistance, junction to case for Diode	-	1.2	K/ W
$R_{th(j-a)}$	Thermal resistance, junction to ambient	-	40	K/ W

Electrical characteristics of IGBT (T_{vj}=25℃ unless otherwise specified)

Static characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
BV_{CES}	Collector-emitter breakdown voltage	V_{GE}=0V, I_C=250μA	1200	-	-	V
I_{CES}	Collector-emitter leakage current	V_{CE}=1200V, V_{GE}=0V	-	-	250	μA
I_{GES}	Gate leakage current, forward	V_{GE}=20V, V_{CE}=0V	-	-	100	nA
	Gate leakage current, reverse	V_{GE}=-20V, V_{CE}=0V	-	-	-100	nA
$V_{GE(th)}$	Gate-emitter threshold voltage	V_{GE}=V_{CE}, I_C=1mA	5.7	6.2	6.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	V_{GE}=15 V, I_C=15A	-	1.7	-	V
		V_{GE}=15V, I_C=15A, T_{vj}=175℃	-	2.2	-	V

Dynamic characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
C_{ies}	Input capacitance	V_{CE}=30V V_{GE}=0V f=1MHz	-	1250	-	pF
C_{oes}	Output capacitance		-	58	-	pF
C_{res}	Reverse transfer capacitance		-	13	-	pF
Q_g	Total gate charge	V_{CC}=960V V_{GE}=15V I_C=15A	-	74	-	nC

Switching characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
$t_{d(on)}$	Turn-on delay time	V_{CC}=600V V_{GE}=0/15V I_C=15A R_G=10Ω Inductive load	-	22	-	ns
t_r	Rise time		-	34	-	ns
$t_{d(off)}$	Turn-off delay time		-	140	-	ns
t_f	Fall time		-	90	-	ns
E_{on}	Turn-on energy		-	0.9	-	mJ
E_{off}	Turn-off energy		-	0.7	-	mJ
E_{ts}	Total switching energy		-	1.6	-	mJ
$t_{d(on)}$	Turn-on delay time	V_{CC}=600V V_{GE}=0/15V I_C=15A R_G=10Ω Inductive load T_{vj} =175℃	-	22	-	ns
t_r	Rise time		-	38	-	ns
$t_{d(off)}$	Turn-off delay time		-	166	-	ns
t_f	Fall time		-	146	-	ns
E_{on}	Turn-on energy		-	1.1	-	mJ
E_{off}	Turn-off energy		-	1.0	-	mJ
E_{ts}	Total switching energy		-	2.1	-	mJ

Electrical characteristics of Diode (T_{vj}=25℃ unless otherwise specified)

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
V_F	Diode forward voltage	I_F=15A	-	2.3	-	V
		I_F=15A，T_{vj}=175℃	-	1.9	-	V
t_{rr}	Diode reverse recovery time	V_R=600V I_F=15A di_F/dt=-250A/μs	-	223	-	ns
I_{rrm}	Diode peak reverse recovery current		-	8	-	A
Q_{rr}	Diode reverse recovery charge		-	718	-	nC
t_{rr}	Diode reverse recovery time	V_R=600V I_F=15A di_F/dt=-250A/μs T_{vj}=175℃	-	396	-	ns
I_{rrm}	Diode peak reverse recovery current		-	11	-	A
Q_{rr}	Diode reverse recovery charge		-	1700	-	nC

Typical performance characteristics

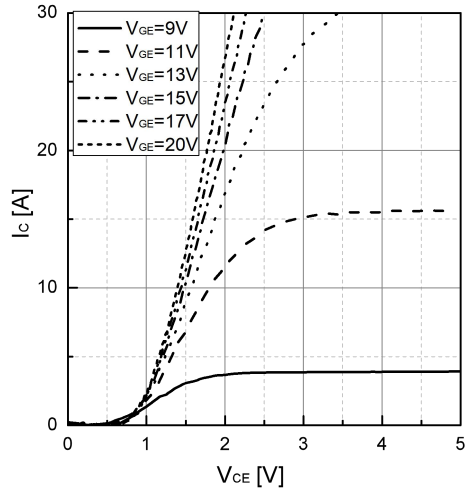


Fig 1. Typical output characteristic (T_{vj}=25℃)

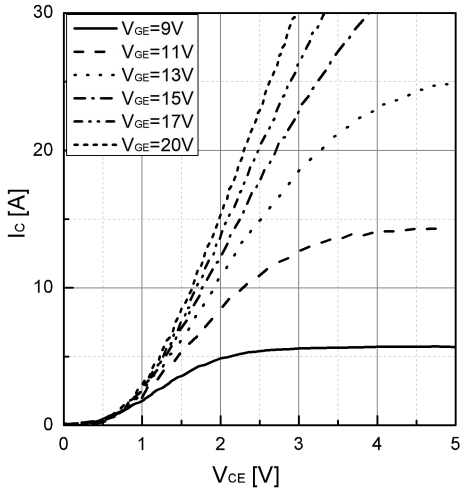


Fig 2. Typical output characteristic(T_{vj}=175℃)

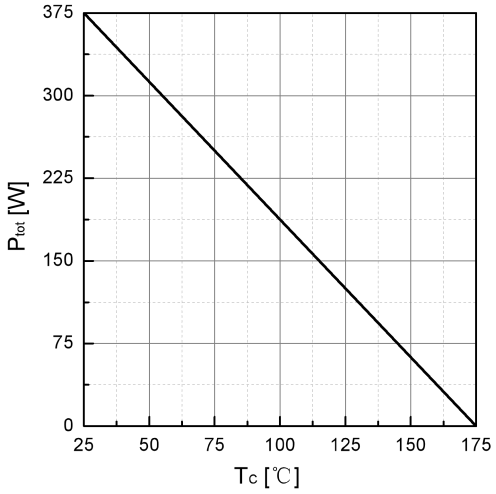


Fig 3. Power dissipation as a function of T_C

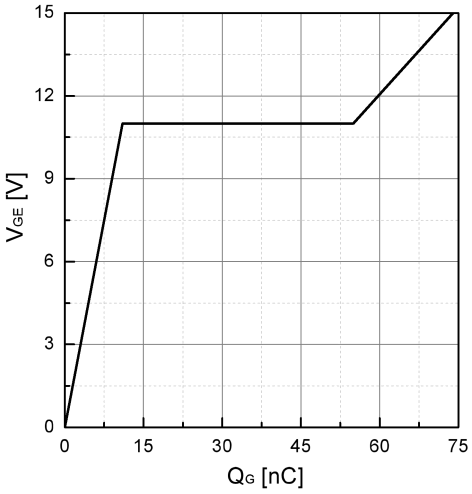


Fig 4. Typical Gate charge

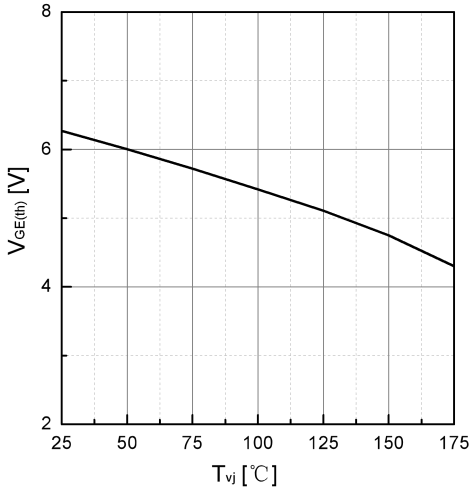


Fig 5. Typical $V_{GE(th)}$ as a function of T_{vj} (I_C=1mA)

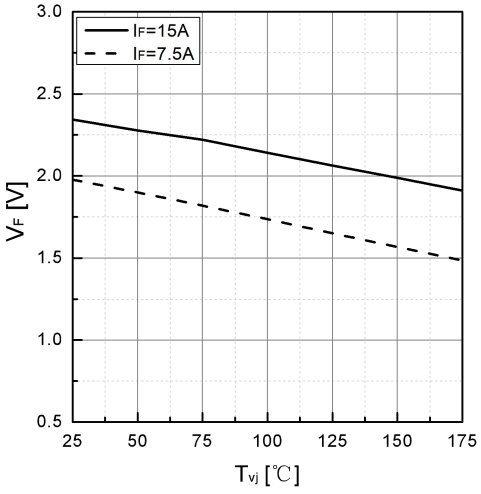


Fig 6. Typical V_F as a function of T_{vj}

Typical performance characteristics

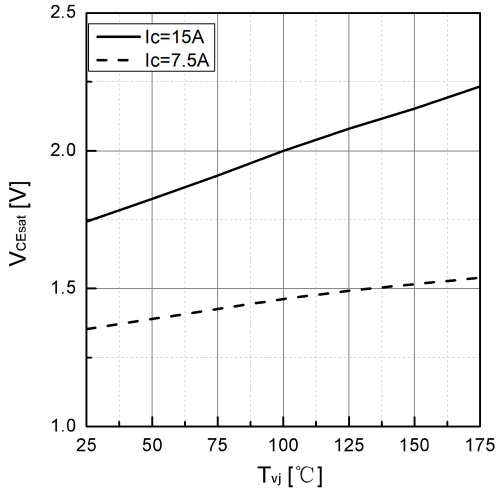


Fig 7. Typical V_{CEsat} as a function of T_{vj}

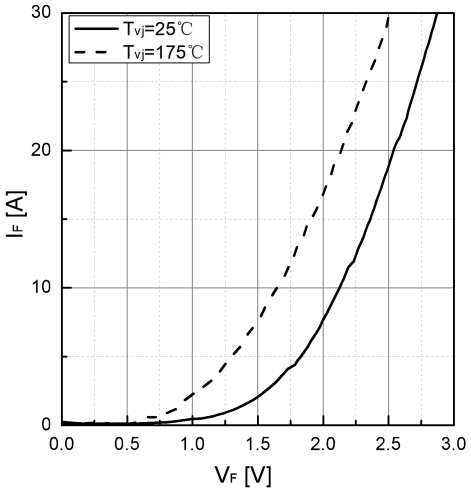


Fig 8. Typical I_F as a function of V_F

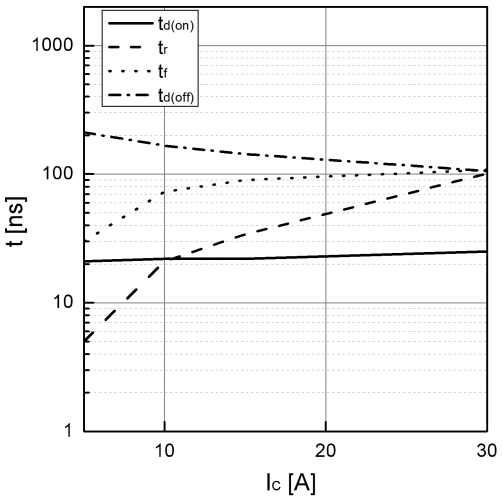


Fig 9. Typical switching time as a function of I_C

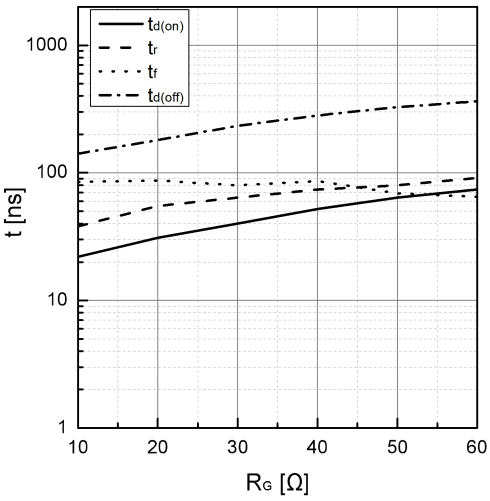


Fig 10. Typical switching times as a function of R_G

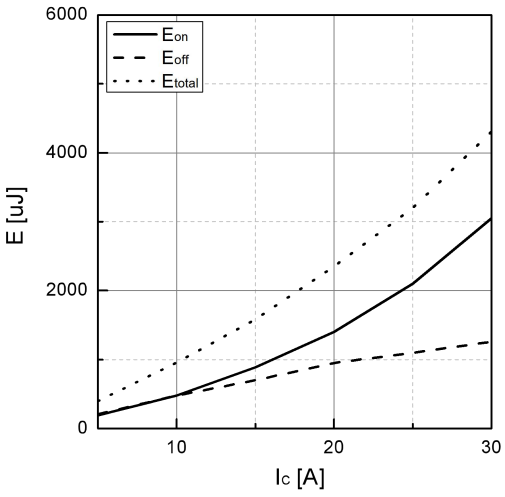


Fig 11. Typical switching energy losses as a function of I_C

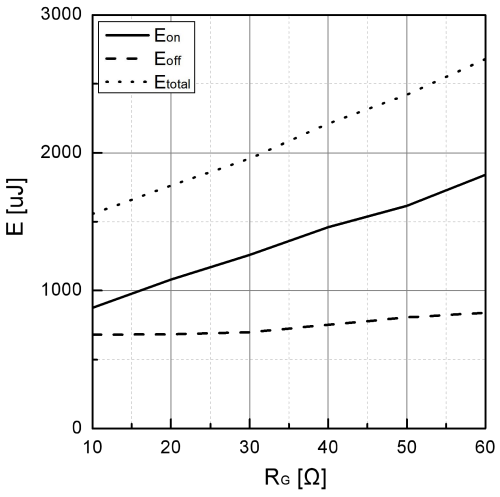


Fig 12. Typical switching energy losses as a function of R_G

Typical performance characteristics

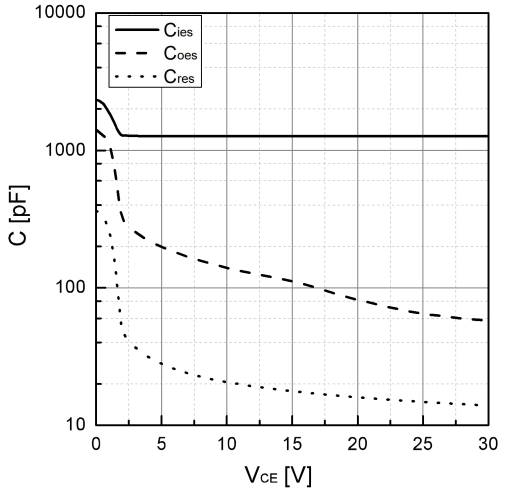


Fig 13. Typical capacitance as a function of V_{CE} (f=1Mhz, V_{GE}=0V)

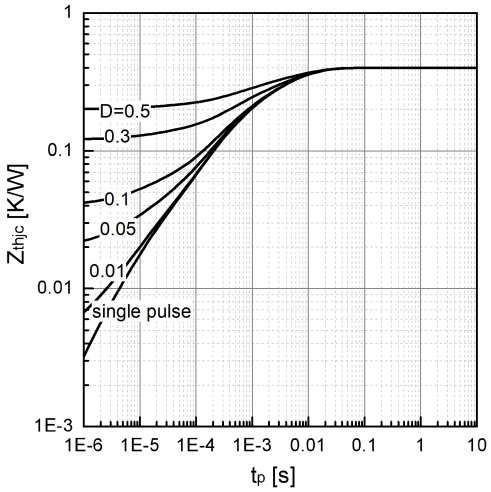


Fig 14. Transient thermal impedance of IGBT

Package dimension

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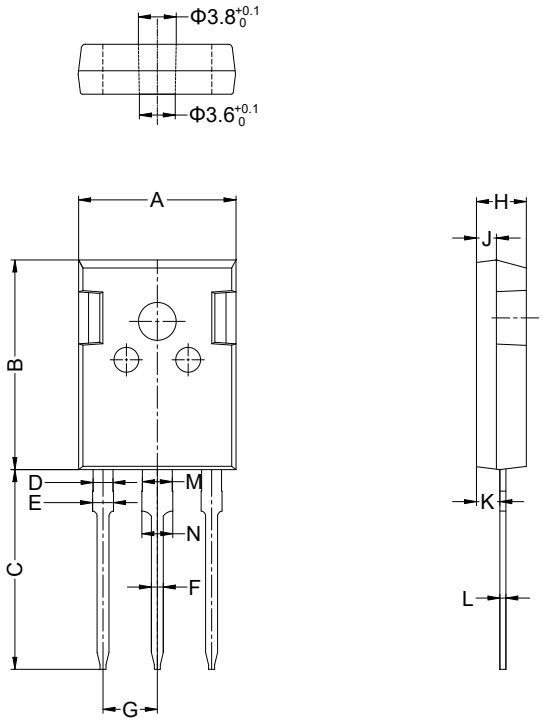

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.50	15.80	16.10	0.610	0.622	0.634
B	20.80	21.00	21.20	0.819	0.827	0.835
C	19.70	20.00	20.30	0.776	0.787	0.799
D	1.80	2.00	2.20	0.071	0.079	0.087
E	1.90	2.10	2.30	0.075	0.083	0.091
F	1.00	1.20	1.40	0.039	0.047	0.055
G	5.25	-	5.65	0.207	-	0.222
H	4.80	5.00	5.20	0.189	0.197	0.205
J	1.90	2.00	2.10	0.075	0.079	0.083
K	2.20	2.35	2.50	0.087	0.093	0.098
L	0.41	0.60	0.79	0.016	0.024	0.031
M	2.80	3.00	3.20	0.110	0.118	0.126
N	2.90	3.10	3.30	0.114	0.122	0.130

Revision history

Date	Revision	Changes
2023-12-12	Rev 1.0	Release of the datasheet
2024-03-20	Rev 1.1	Update
2024-05-17	Rev 1.2	Update

Disclaimer